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S-5840B Series

Rev.2.1 01

www.sii-ic.com

TEMPERATURE SWITCH IC (THERMOSTAT IC) WITH LATCH

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The S-5840B Series is a temperature switch IC (thermostat IC) with a latch function which detects the temperature with a temperature accuracy of $\pm 2.5^{\circ}$ C. When the temperature reaches the detection temperature, the output signal is inverted and being latched until the S-5840B Series detects decrease in a power supply voltage.

The S-5840B Series operates at the lower power supply voltage of 1.0 V and its current consumption is 12 μ A typ. due to CMOS configuration.

The S-5840B Series has a temperature sensor using negative temperature coefficient, a reference voltage generation circuit, comparator, voltage detection circuit and noise suppression circuit on a chip, and they are enclosed in package SOT-23-5.

 $I_{DD} = 12 \ \mu A \ typ.$ (Ta = +25°C).

Features

- Detection temperature: T_{DET} = +55 to +95°C, +1°C step, detection accuracy: ±2.5°C
- Wide voltage operation: V_{DD} = 1.0 V to 10.0 V
- Release voltage: V_{RET} = 2.2 V to 3.4 V, 0.1 V step
- Low current consumption:
- Built-in noise suppression circuit for preventing temperature detection malfunction
- Output logic level is fixed by the latch after temperature detection.
- Selectable output logic in active "H" or "L"
- Selectable output form in CMOS or Nch open drain
- Operation temperature range: $Ta = -40^{\circ}C$ to $+100^{\circ}C$
- Lead-free, Sn 100%, halogen-free*1

*1. Refer to "
Product Name Structure" for details.

Applications

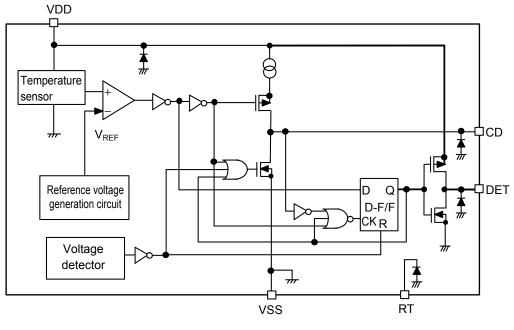
- Game console
- Electronic device

Package

• SOT-23-5

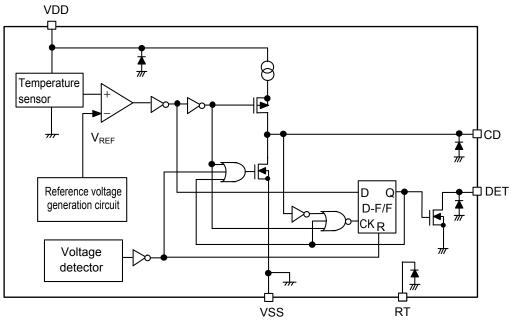
Block Diagrams

1. CMOS output product





2. Nch open drain output product

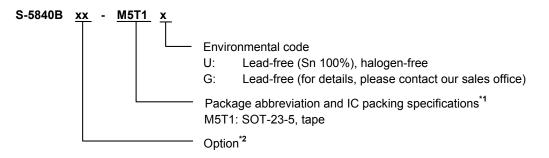




Product Name Structure

Users are able to select the option for detection temperature, output form and logic, release voltage for the S-5840B Series.

1. Product name



- ***1.** Refer to the tape drawing.
- *2. Option list
 - The detection temperature (T_{DET}) can be set in the range of +55°C to +95° at 1°C step.
 - The DET pin output can be selected the output logic in active "H" or "L".
 - The DET pin output can be selected the output form in CMOS or Nch open drain.
 - The release voltage (V_{RET}) can be set in the range of 2.2 V to 3.4 V at 0.1 V step.

2. Package

Table 1	Package	Drawing	Codes
	I acrage	Diawing	ooues

Package Name	Dimension	Таре	Reel
SOT-23-5	MP005-A-P-SD	MP005-A-C-SD	MP005-A-R-SD

3. Product name list

Table 2

Product Name	Detection Temperature (T _{DET})	DET Pin Output Form	DET Pin Output Logic	Release Voltage (V _{RET})
S-5840BAG-M5T1x	+60°C	CMOS	Active "L"	2.9 V
S-5840BAH-M5T1x	+90°C	CMOS	Active "H"	2.9 V
S-5840BAJ-M5T1x	+80°C	Nch open drain	Active "L"	2.2 V

Remark 1. Please contact our sales office for options other than that specified above.

2. x: G or U

3. Please select products of environmental code = U for Sn 100%, halogen-free products.

Pin Configuration

1. SOT-23-5

Top view



Figure 3

Pin No.	Symbol	Description
1	RT ^{*1}	Test pin
2	VSS	GND pin
3	CD	Capacitor connection pin for setting malfunction prevention time
4	DET	Output pin
5	VDD	Power supply pin

Table 3

*1. Set the RT pin open in use.

Absolute Maximum Ratings

Table 4

		(Ta = +25°C unless otherwise	e specified		
Item	Symbol	Absolute Maximum Rating	Unit		
age (V _{SS} = 0 V)	V _{DD}	V _{SS} + 12	V		
	Vrt, Vcd	$V_{\text{SS}}-0.3$ to $V_{\text{DD}}+0.3$	V		
CMOS output		$V_{\text{SS}}-0.3$ to $V_{\text{DD}}+0.3$	V		
Nch open drain output	VDET	$V_{SS} - 0.3$ to $V_{SS} + 12.0$	V		
Power dissipation		300 (when not mounted on board)	mW		
		600 ^{*1}	mW		
Operating temperature		perating temperature		-40 to +100	°C
Storage temperature		-55 to +125	°C		
	CMOS output CMOS output Nch open drain output	CMOS output VDD CMOS output VDET Nch open drain output VDET PD PD rature Topr	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		

***1.** When mounted on board

[Mounted board]

(1) Board size: 114.3 mm \times 76.2 mm \times t1.6 mm

(2) Board name: JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

Recommended Values for External Parts

Table 5

Item	Symbol	Value	Unit
CD capacitance	CD	4.7	nF

Rev.2.1_01

DC Electrical Characteristics

1. CMOS output product

Table 6

				(Ta = +25°C,	unless other	wise sp	ecified)
Item	Symbol	Cond	ition	Min.	Тур.	Max.	Unit	Test Circuit
Power supply voltage	V _{DD}	-		1.0	_	10.0	V	1
Detection temperature	+T _D	_		Tdet - 2.5	TDET	T _{DET} + 2.5	°C	1
	IDETH	V_{DD} = 3.5 V,	V _{DET} = 2.7 V	2	9.4	_	mA	2
Output current	Idetl	Apply to DET pin	V _{DET} = 0.4 V	0.5	2.8	-	mA	2
Release voltage for built-in voltage detector	V _R	_		$V_{\text{RET}} \times 0.98$	V _{RET}	$V_{RET} imes 1.02$	V	_
Hysteresis width for built-in voltage detector	V _{HYS}	_		-	$V_{\text{RET}} \times 0.05$	-	V	_
Temperature coefficient for built-in voltage detector	$\frac{\Delta V_{\text{RET}}}{\Delta Ta \bullet V_{\text{RET}}}$	Ta =	o +100°C	-	±100	-	ppm/°C	_
Current consumption during operation	I _{DD}	V _{DD} = 3.5 V		_	12	24	μA	1

2. Nch open drain output product

Table 7

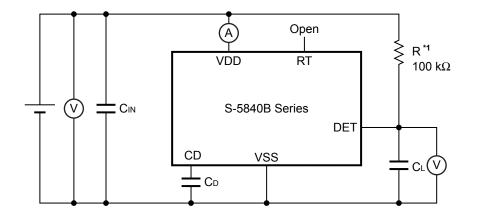
			(Ta = +25°C,	unless other	wise sp	ecified)
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Power supply voltage	V _{DD}	_	1.0	-	10.0	V	1
Detection temperature	+T _D	_	T _{DET} – 2.5	TDET	T _{DET} + 2.5	°C	1
Output ourreat	IDETL	V_{DET} = 0.4 V, V_{DD} = 3.5 V	0.5	2.8	-	mA	2
Output current	I _{LEAK}	V_{DET} = 10.0 V, V_{DD} = 3.5 V	_	-	100	nA	2
Release voltage for built-in voltage detector	VR	_	$V_{\text{RET}} \times 0.98$	V _{RET}	$V_{RET} imes 1.02$	V	-
Hysteresis width for built-in voltage detector	V _{HYS}	_	-	$V_{RET} imes 0.05$	-	V	-
Temperature coefficient for built-in voltage detector	$\frac{\Delta V_{\text{RET}}}{\Delta Ta \bullet V_{\text{RET}}}$	Ta = -40°C to +100°C	_	±100	_	ppm/°C	_
Current consumption during operation	I _{DD}	V _{DD} = 3.5 V	_	12	24	μA	1

■ AC Electrical Characteristics

Table 8

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Noise suppression time	t _{noise}	C_D = 4.7 nF, V_{DD} = 3.5 V, Ta = detection temperature	10	30	50	ms	-

Test Circuits



***1.** Resistor (R) is unnecessary for the CMOS output product.

Figure 4 Test Circuit 1

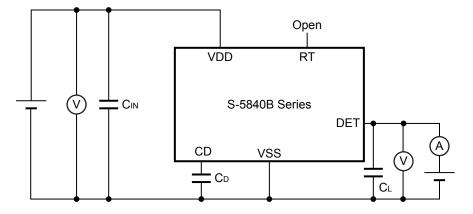


Figure 5 Test Circuit 2

Operation

1. Basic operation

The S-5840B Series is a temperature switch IC (thermostat IC) which detects the temperature and sends a signal to an external device. The users can select a combination of the parameters such as detection temperature and release voltage.

Following is about the operation when the DET pin output logic is active "H".

When the power supply voltage is turned on, the DET pin voltage goes to "L" since the flip-flop circuit in the detection circuit is cleared by the voltage detection circuit. Temperature detection then starts and the DET pin is held "L" as long as the temperature is lower than the detection temperature. When the temperature rises and when the temperature exceeds the detection temperature; longer than the time defined by the capacitor connected to the CD pin, the DET pin goes to "H". Once the over-temperature is detected and the DET pin goes to "H", the state is held by the flip-flop circuit. In order to release the state, the power supply voltage should be set under the detection voltage ($V_R - V_{HYS}$) of the built-in voltage detector circuit to reset the internal circuit.

Using the internal reference voltage and built-in temperature sensor, a detection temperature accuracy of $\pm 2.5^{\circ}$ C is achieved in the S-5840B Series.

2. Noise suppression circuit

The noise suppression circuit prevents malfunction of the temperature switch caused by noise.

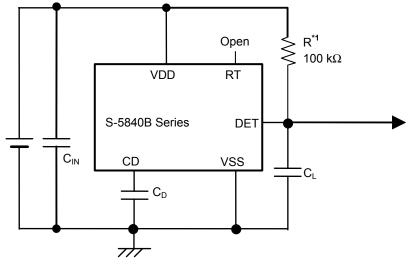
The noise suppression circuit starts charging the capacitor connected to the CD pin when the output of the internal comparator enters the active state due to an external noise or a rapid change in the power supply voltage. In the normal operation, the flip-flop circuit is set when the capacitor is charged to a certain voltage. But in the noise triggered operation, the comparator output goes back to the inactive state and the CD pin voltage is held "L" since the charging of the external capacitor (C_D) is insufficient. As a result, the DET pin is held "L" and malfunction does not occur.

Noise suppression time (t_{noise}) is determined by the time constant consisting of internal constant current and the capacitance of the C_D , and calculated by the following equation.

 t_{noise} (ms) = Noise suppression time coefficient × C_D (nF) Noise suppression time coefficient (Ta = +25°C): 6.4 typ.

The C_D has no limitation as long as its leak current is negligible compared to the internal constant current. The difference occurs in delay time if the capacitor has a leak current.

Standard Circuit



*1. Resistor (R) is unnecessary for the CMOS output product.

Figure 6

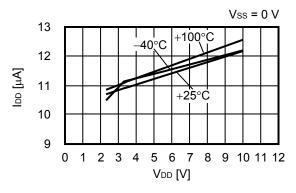
Caution The above connection diagram will not guarantee successful operation. Perform thorough evaluation using actual application to set the constant.

Precautions

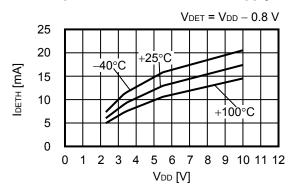
- Set a capacitor (C_{IN}) of 0.1 μ F or more between VDD and VSS pin for stabilization.
- A capacitor (C_L) of about 1 μF should be connected to the DET pin to prevent malfunction caused by noise due to the power being on.
- Do not connect a capacitor to the RT pin (leave the RT pin open). Otherwise, this IC may oscillate.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- SII Semiconductor Corporation claims no responsibility for any disputes arising out of or in connection with any infringement by products, including this IC, of patents owned by a third party.

Characteristics (Typical Data)

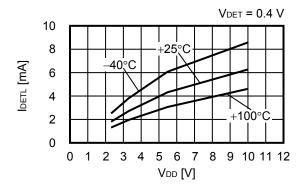
1. Current consumption vs. Power supply voltage characteristics



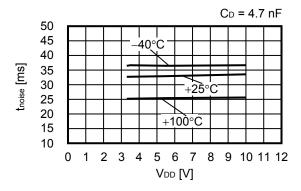
2. DET pin current "H" vs. Power supply voltage characteristics (CMOS output product only)



3. DET pin current "L" vs. Power supply voltage characteristics

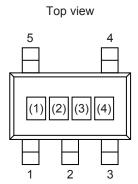


4. Noise suppression time vs. Power supply voltage characteristics



Marking Specification

1. SOT-23-5



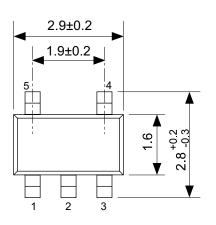
(1) to (3): (4): Product code (refer to Product name vs. Product code) Lot number

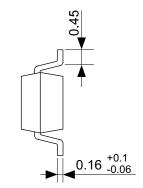
Product name vs. Product code

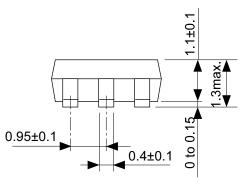
Draduat Nama	Product Code				
Product Name	(1)	(2)	(3)		
S-5840BAG-M5T1x	Н	8	М		
S-5840BAH-M5T1x	Н	8	Ν		
S-5840BAJ-M5T1x	Н	8	0		

Remark 1. x: G or U

2. Please select products of environmental code = U for Sn 100%, halogen-free products.

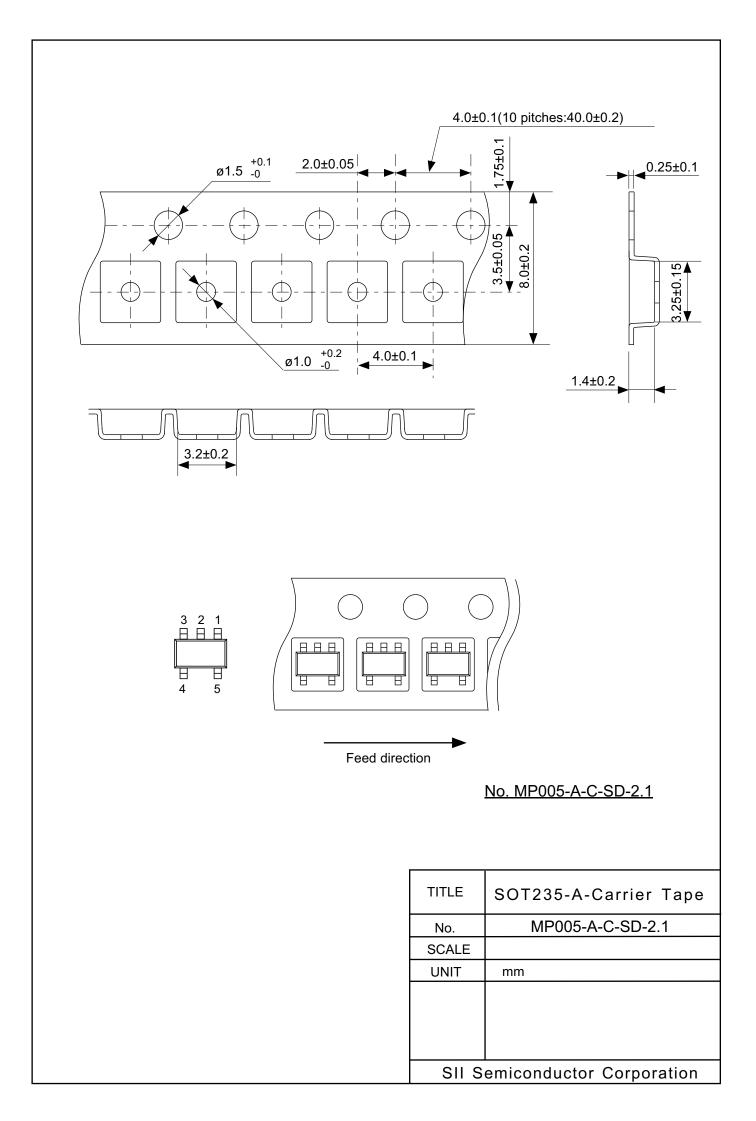


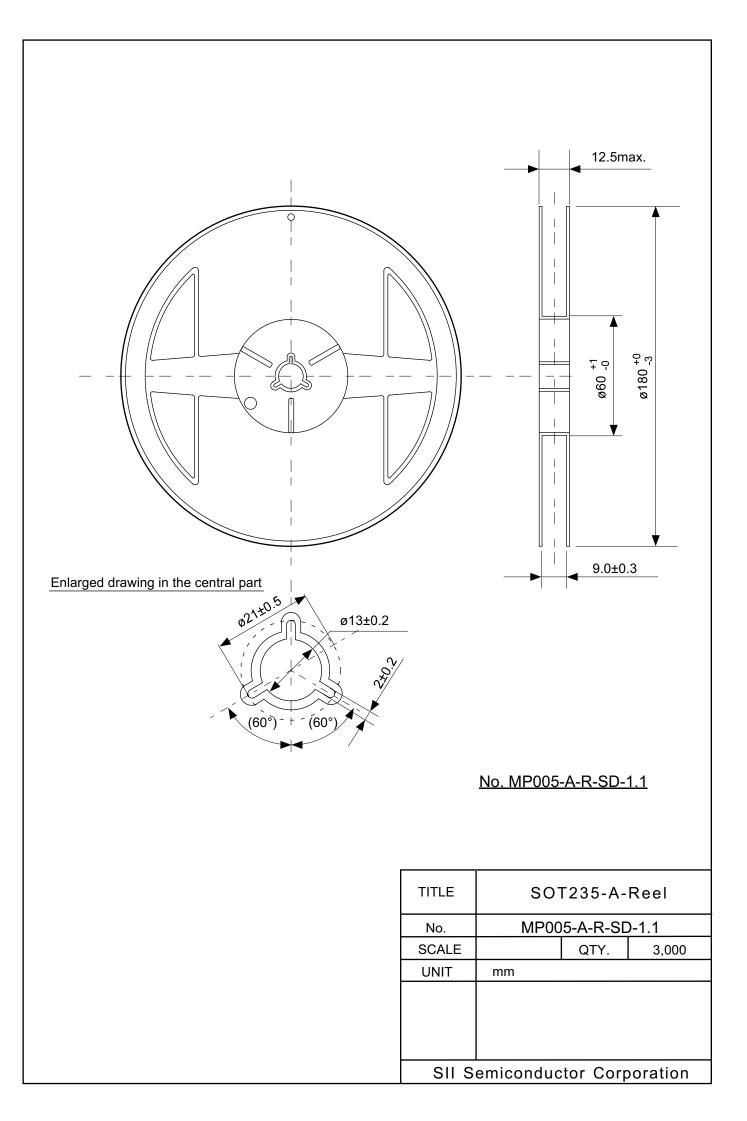




No. MP005-A-P-SD-1.2

TITLE	SOT235-A-PKG Dimensions
No.	MP005-A-P-SD-1.2
SCALE	
UNIT	mm
SII S	emiconductor Corporation





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